onsemi

MARKING

ESD Protection Diodes

Micro-packaged Diodes for ESD Protection

ESD5101, ESD5111

The ESD51x1 Series is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in smartphone, smart-watch, or many other portable / wearable applications where board space comes at a premium.

Features

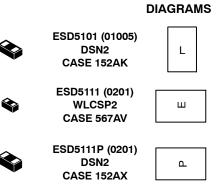
- Low Capacitance (5 pF Max, I/O to GND)
- Small Body Outline Dimensions
 - ◆ 01005 Size: 0.435 x 0.23 mm
 - ◆ 0201 Size: 0.6 x 0.3 mm
- Protection for the Following IEC Standards: IEC 61000-4-2 (Level 4)
- Low ESD Clamping Voltage
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

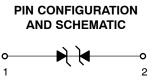
| Rating | Symbol | Value | Unit |
|--|------------------|-------------|----------|
| Operating Junction Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |
| Lead Solder Temperature – Maximum (10 Seconds) | ΤL | 260 | °C |
| IEC 61000-4-2 Contact (ESD) IEC 61000-4-2 Air (ESD) | ESD ESD | ±15 ±15 | kV kV |

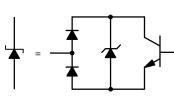
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

See Application Note AND8308/D for further description of survivability specs.



L, E, P = Device Code





ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ESD5101, ESD5111

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|------------------|--|------|-----|-----|------|
| Reverse Working Voltage | V _{RWM} | I/O Pin to GND | | | 3.3 | V |
| Breakdown Voltage | V _{BR} | I _T = 1 mA, I/O Pin to GND | 3.68 | 5.0 | 6.5 | V |
| Reverse Leakage Current | I _R | V _{RWM} = 3.3 V, I/O Pin to GND | | | 0.1 | μA |
| ESD5101, ESD5111 Clamping Voltage TLP (Note 1) | V _C | $I_{PP} = 8 A $ $\begin{cases} IEC 61000-4-2 \text{ Level 2 equivalent} \\ (\pm 4 \text{ kV Contact}, \pm 4 \text{ kV Air}) \end{cases}$ | | 5.5 | | V |
| | | $I_{PP} = 16 A \\ \left. \begin{array}{c} \text{IEC } 61000 - 4 - 2 \text{ Level } 2 \text{ equivalent} \\ (\pm 8 \text{ kV Contact, } \pm 15 \text{ kV Air}) \end{array} \right.$ | | 6.5 | | |
| Junction Capacitance | CJ | $V_R = 0 V$, f = 1 MHz | | | 5.5 | pF |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. ANSI/ESD STM5.5.1 – Electrostatic Discharge Sensitivity Testing using Transmission Line Pulse (TLP) Model. TLP conditions: $Z_0 = 50 \ \Omega$, $t_p = 100 \ ns$, $t_r = 4 \ ns$, averaging window; $t_1 = 30 \ ns$ to $t_2 = 60 \ ns$.

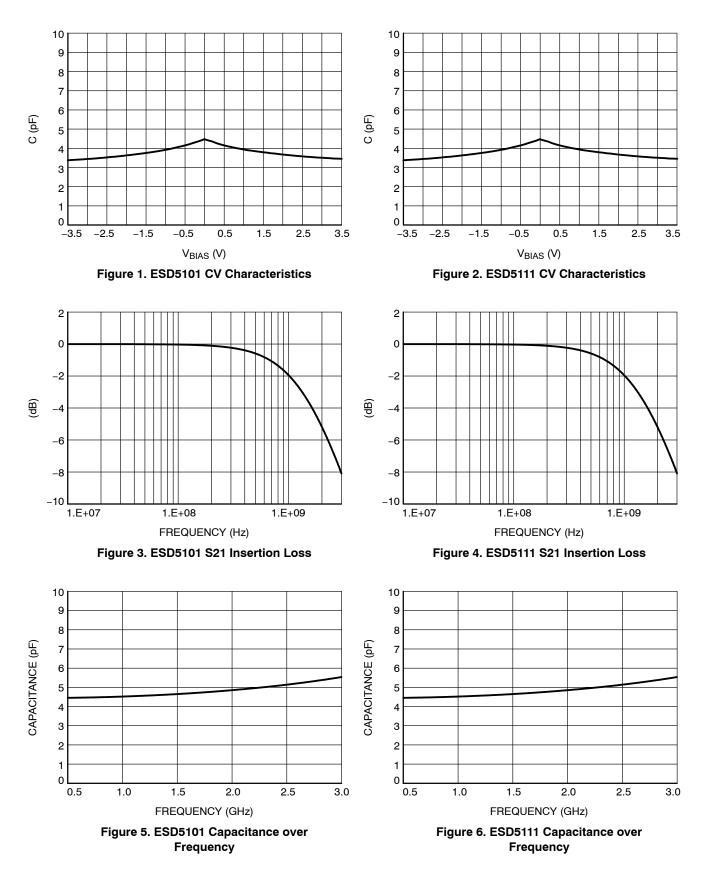
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|---------------------|-----------------------|
| ESD5101FCT5G | DSN2 (Pb-Free) | 10,000 / Tape & Reel |
| ESD5111FCT5G | WLCSP2 (Pb-Free) | 10,000 / Tape & Reel |
| ESD5111PFCT5G | DSN2 (Pb-Free) | 10,000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

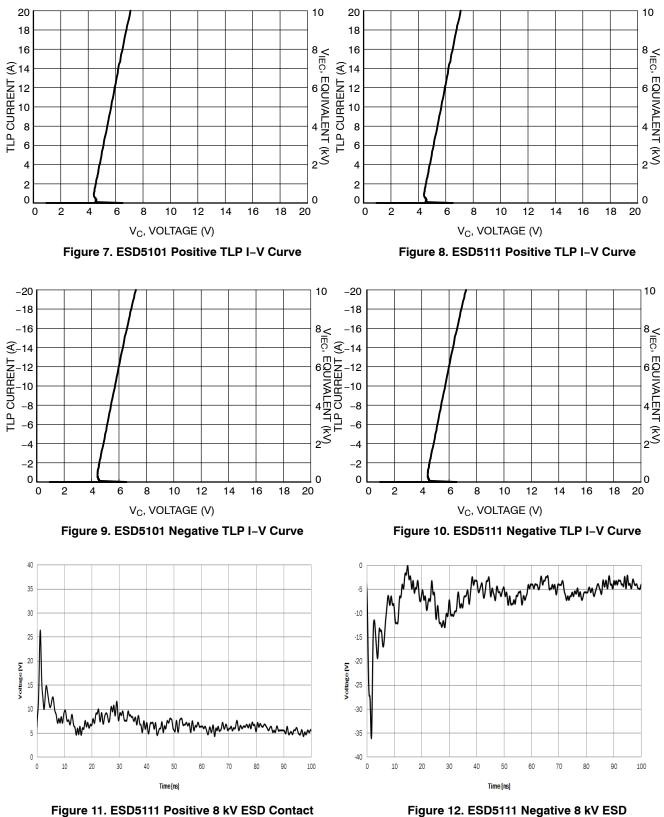
ESD5101, ESD5111

TYPICAL CHARACTERISTICS



ESD5101, ESD5111

TYPICAL CHARACTERISTICS



Contact Discharge

Discharge

IEC 61000-4-2 Spec.

| Level | Test Volt- age (kV) | First Peak Current (A) | Current at 30 ns (A) | Current at 60 ns (A) |
|-------|------------------------|------------------------------|-------------------------|-------------------------|
| 1 | 2 | 7.5 | 4 | 2 |
| 2 | 4 | 15 | 8 | 4 |
| 3 | 6 | 22.5 | 12 | 6 |
| 4 | 8 | 30 | 16 | 8 |

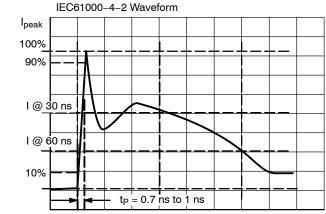


Figure 13. IEC61000-4-2 Spec

Transmission Line Pulse (TLP) Measurement

Transmission Line Pulse (TLP) provides current versus voltage (I–V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 14. TLP I–V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 15 where an 8 kV IEC 61000–4–2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP I–V curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels.

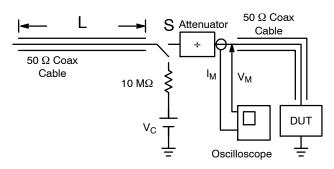


Figure 14. Simplified Schematic of a Typical TLP System

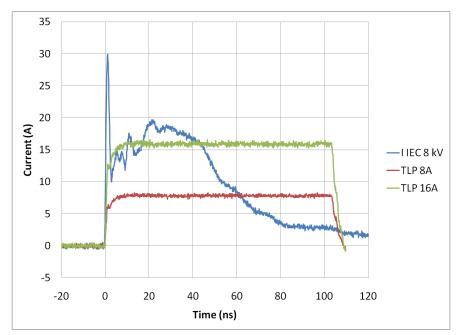


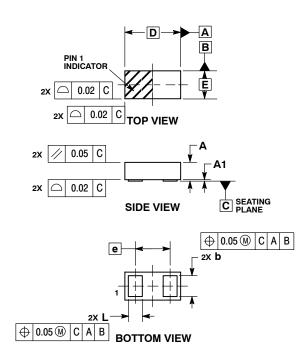
Figure 15. Comparison Between 8 kV IEC 61000-4-2 and 8 A and 16 A TLP Waveforms





DSN2, 0.435x0.23, 0.27P, (01005) CASE 152AK ISSUE A

DATE 17 FEB 2015



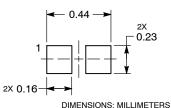
NOTES: DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS. MILLIMETERS
 DIM
 MIN
 MAX

 A
 0.165
 0.195

 A1
 -- 0.030

 b
 0.177
 0.193

 D
 0.435
 BSC
 E 0.230 BSC е 0.270 BSC L 0.112 0.128 GENERIC **MARKING DIAGRAM*** Б Х X = Specific Device Code *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. RECOMMENDED **SOLDER FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting

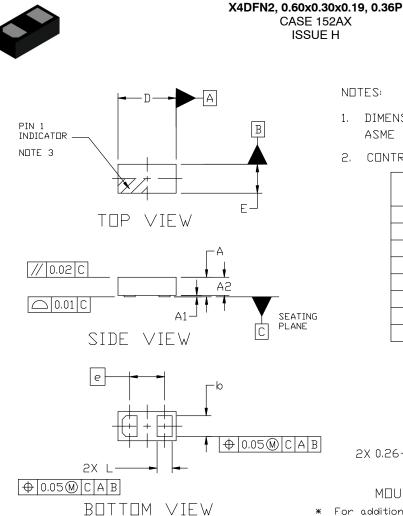
details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, <u>SOLDERRM/D</u>.

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| DESCRIPTION: | DSN2, 0.435X0.23, 0.27P (01005) | | PAGE 1 OF 1 | | |
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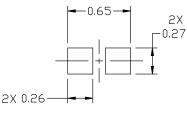
ISEM

DATE 01 AUG 2023



- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS

| | MILLIMETERS | | | |
|-----|-------------|-----------|-------|--|
| DIM | MIN. | NDM. | MAX. | |
| Α | 0.175 | 0.200 | 0.225 | |
| A1 | (| 0.018 REF | | |
| A2 | 0.180 | 0.190 | 0.200 | |
| b | 0.205 | 0.215 | 0.225 | |
| D | 0.575 | 0.600 | 0.625 | |
| E | 0.275 | 0.300 | 0.325 | |
| e | 0.36 BSC | | | |
| L | 0.145 | 0.155 | 0.165 | |



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC **MARKING DIAGRAM***



X = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. Some products may not follow the Generic Marking.

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|------------------|---|--|-------------|--|
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| | | | | |

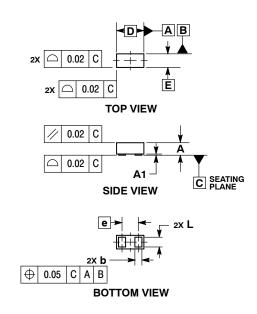
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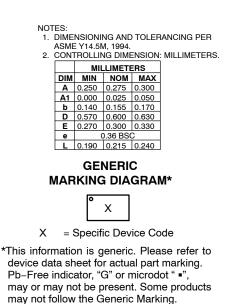




WLCSP2, 0.6x0.3 CASE 567AV ISSUE C

DATE 22 SEP 2017





RECOMMENDED SOLDER FOOTPRINT*

DIMENSIONS: MILLIMETERS

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| DESCRIPTION: | WLCSP2, 0.6X0.3 | | PAGE 1 OF 1 | |
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